

In the Title

Amend the title as follows:

METHOD FOR INDUCTIVELY HEATING A COATED SUBSTRATE ~~AND A~~
~~COATING ON SAID SUBSTRATE~~

In the Specification

The specification has been amended as follows:

Amend the paragraph beginning at page 2 line 1 as follows:

[0005] Advantageously, the susceptor element may function as a mould as described in more detail in our copending U.S. ~~patent application serial No. 09/684,788 filed October 10, 2000~~ International Application No. WO 02/30653 published on April 18, 2002, the disclosures of which are incorporated herein by reference.

Amend the paragraph beginning at page 3 line 12 as follows:

[0010] For the purpose of applying a heat shrink sleeve over the joint area, it is desired to heat the coatings 14 and 16 in the regions that will be overlapped by the sleeve and slightly outwardly beyond the edges of the sleeve to a temperature in excess of the activation temperature for the sleeve, for example as described in our above-mentioned

International Application No. WO 02/30653 published on April 18, 2002, patent application serial No. 09/684,788.

Amend the paragraph beginning at page 3 line 34 as follows:

[0015]When the bare portions 19 and 21 and the coatings 14 and 16 have achieved desired temperatures, the induction coil is slid longitudinally to one side, the susceptor elements 22 and insulation bands 23 removed and a heat activatable sleeve is applied over the pipe joint area. Such sleeves and the techniques for applying them are well known to those skilled in the art, and sleeves may be applied in a conventional manner. In a preferred form, however, a sleeve may be applied as described in our above-mentioned International Application No. WO 02/30653 published on April 18, 2002, patent application No. PCT/CA01/01425.

Amend the paragraph beginning at page 5 line 28 as follows:

[0023]The induction heating was applied until the coating surface, heated by conduction from the underlying substrate, attained a temperature of 160°C. At this point, the steel had attained a temperature of 200°C. There was some blistering and delamination of the coating, and this was prevented by use of a silicon rubber mould band wrapped around the coating as described in above mentioned

International Application No. WO 02/30653 published on April
18, 2002, patent application No. 09/685,788.